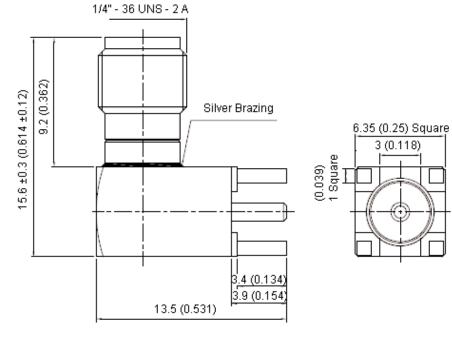
multicomp	PART NO.		REVISIONS							
	60-05 TGG	ECN #	REV	DESCRIPTION	DRAWN	DATE	CHECKD	DATE	APPRVD	DATE
		-	А	RELEASED	Asha	25/11/11	Veena	25/11/11		09/12/11



	(0.201)
	5.1 Reference
ence	
(0.201) Reference	
بن 1-	<del>.</del> ФФ-
	Mounting Hole
(1)	Ø1.4 (0.055) Minimum

#### (1) Ø1.4 (0.055) Minimun (4) Ø1.5 (0.059) Minimun

Dimensions : Millimetres (Inches)

## Specifications:

Operating temperature range

### Electrical:

	Frequency range Nominal impedance Maximum working voltage Proof voltage Maximum VSWR	: DC - 12.4 GHz : 50 Ω : 500 V : 1,000 V : 1.23
-	Materials:	
	Bodies	: Brass beryllium copper per ASTM B196 UNS C17300
	Centre contact	: Beryllium copper per ASTM B196 UNS C17300
<b>,</b> m	Insulation	: Teflon per ASTM D1457 and ASTM D1710
m s)	Finishes and Others:	
	See below table for details	
	Mechanical:	
	Interface in accordance with	: MIL-STD-348A
	Environmental:	

: -65°C to +165°C

RoHS Compliant

 Tolerance

 .X
 ±0.2

 .XX
 ±0.1

 .XXX
 ±0.05

 Angle
 ±5°

licence is granted for the use of it other than for information purposes in connection with	TOLERANCES:	DRAWN BY: Asha	DATE:	DRAWING TITLE:	CB Mount Recept	acle - Right Ar	ale
Information is subject to change without notice and replaces all data sheets previously sup- plied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on	UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE FOR REFERENCE	CHECKED BY: Veena	DATE: 25/11/11		M10002760	ELECTRONIC FILE 60-0005 DWG	REV A
	PURPOSES ONLY.	APPROVED BY:	DATE: 09/12/11	SCALE: NTS	U.O.M.: mm (Inches)	SHEET: 1	OF 2

multicomp	PART NO.		REVISIONS							
	60-05 TGG	ECN #	REV	DESCRIPTION	DRAWN	DATE	CHECKD	DATE	APPRVD	DATE
		-	А	RELEASED	Asha	25/11/11	Veena	25/11/11		09/12/11

# Specification Table

No.	Description	Material	Finish
1	Chassis	Beryllium Copper	Gold 3 µ Inches Minimum Over Electroless Nickel 50 µ Inches Minimum
2	Insulation I	Teflon	None
3	Center Contact I	Beryllium Copper	Gold 50 µ Inches Minimum Over Electroless Nickel 50 µ Inches Minimum
4	Body	Berymum Copper	Gold 3 $\mu$ Inches Minimum Over Electroless Nickel 50 $\mu$ Inches Minimum
5	Insulation II	Teflon	None
6	Center Contact II	Beryllium Copper	Gold 50 µ Inches Minimum Over Electroless Nickel 50 µ Inches Minimum
7	Сар	Derymani Copper	Gold 3 µ Inches Minimum Over Electroless Nickel 50 µ Inches Minimum

# Part Number Table

Description	Part Number
Jack, SMA, PCB SMT, NON-MAG	60-05 TGG

www.element14.com

www.farnell.com

www.newark.com

bers of the Frenheir affeir group of companies (the Group ) of are needed to it. No	TOLERANCES:	DRAWN BY:	DATE:	DRAWING TITLE:						
plied. The information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on	UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE FOR REFERENCE PURPOSES ONLY.	Asha	25/11/11	SMA PCB Mount Receptacle - Right Angle						
		CHECKED BY:	DATE:	SIZE DWG NO.		ELECTRONIC FILE 60-0005_DWG		REV		
		Veena	25/11/11	Δ	M10002760			A		
		APPROVED BY:	DATE:		U.O.M.: mm (Inches)					
			09/12/11	SCALE: NTS			SHEET: 2	OF 2		